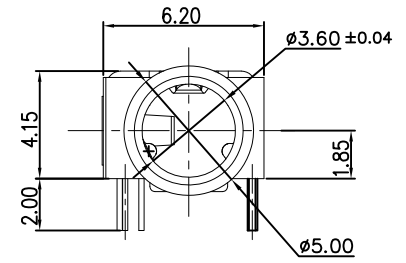
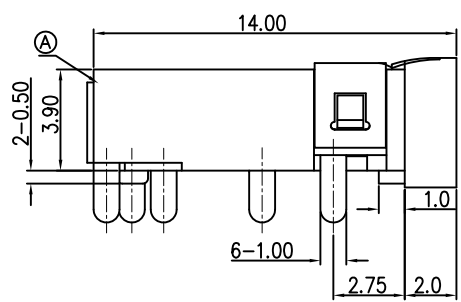
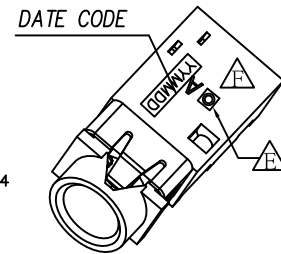


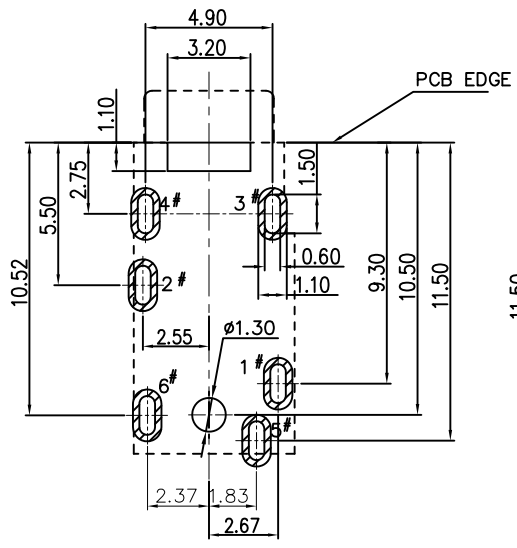
REV.	ECN NO OR DESCRIPTION	REVISED	DATE
D	ECN NO: T080204 增加無齒包裝標示	CHARLIE	12/25'08
E	ECN NO: C110322 Modify drawing	LONGJIANG	2011.10.13
F	ECN NO: C140043 UPDATE DRAWING	ZLS	2014.7.4



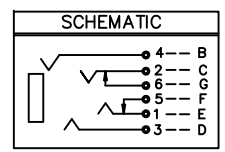
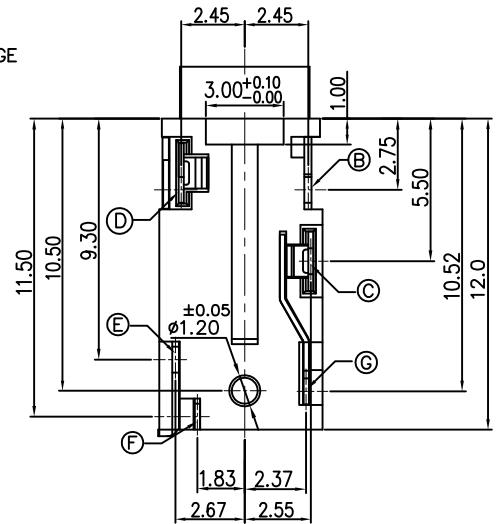
SPECIFICATIONS:

- ELECTRICAL CHARACTERISTICS:**
 - RATING: 16V 0.3A
 - CONTACT RESISTANCE: 30mΩ MAX.(INITIAL)
 - DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR ONE MINUTE.
 - INSULATION RESISTANCE: 100MΩ/MIN. MEASURED BY 500 VDC
- MECHANICAL CHARACTERISTICS:**
 - INSERTION FORCE : 0.3~3.0 KGF
 - WITHDRAWAL FORCE : 0.3~3.0 KGF
- LIFE TEST: 8,000 CYCLES MIN.**
- OTHER GENERAL SPEC. TO REFER "2SJ0386 SERIES SPEC".**
- TO CONFORM TO SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.**
- HALOGEN PRODUCT IDENTIFICATION MARK: (Symbol)**
- HALOGEN PRODUCT IDENTIFICATION LABEL ON PACKAGING: (Symbol)**
- FOR REFLOW SOLDERING LEAD-FREE PROCESS.**
- PACKAGING: TAPE&REEL**
- PRINTED DATE CODE"YYMMDD" ON TOP OF CONNECTOR.**

YY MM DD
 DD: DAY
 MM: MONTH
 YY: YEAR



RECOMMENDED PCB LAYOUT
TOP VIEW (.XX±0.05)



NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
G	SHUNT TERMINAL-B	1	COPPER ALLOY 0.2t	GOLD PLATING
F	SHUNT TERMINAL-A	1	COPPER ALLOY 0.2t	GOLD PLATING
E	TIP SPRING	1	COPPER ALLOY 0.25t	GOLD PLATING
D	RING SPRING B	1	COPPER ALLOY 0.2t	GOLD PLATING
C	RING SPRING A	1	COPPER ALLOY 0.2t	GOLD PLATING
B	EARTH	1	COPPER ALLOY 0.25t	GOLD PLATING
A	BODY	1	HIGH TEMP. THERMOPLASTIC UL 94V-0	BLACK COLOR

UNLESS OTHERWISE SPECIFIED TOLERANCES		Singatron Enterprise Co., Ltd. 信音企業股份有限公司	
DECIMALS:	ANGLES:	TITLE	φ3.5 PHONE JACK
X : ±0.5	X : ±2°	DWN	ZLS 14/7/11 PART NO. 2SJ-0386-D03
XX : ±0.3	XX : ±1°	CHKD	BILLY 14/7/11 SCALE 5:1 UNIT: mm
XXX : ±0.2		APVD	ZJZ 14/7/11 SIZE: A3 SHEET: 10F1 REV: F
CUSTOMER COPY			